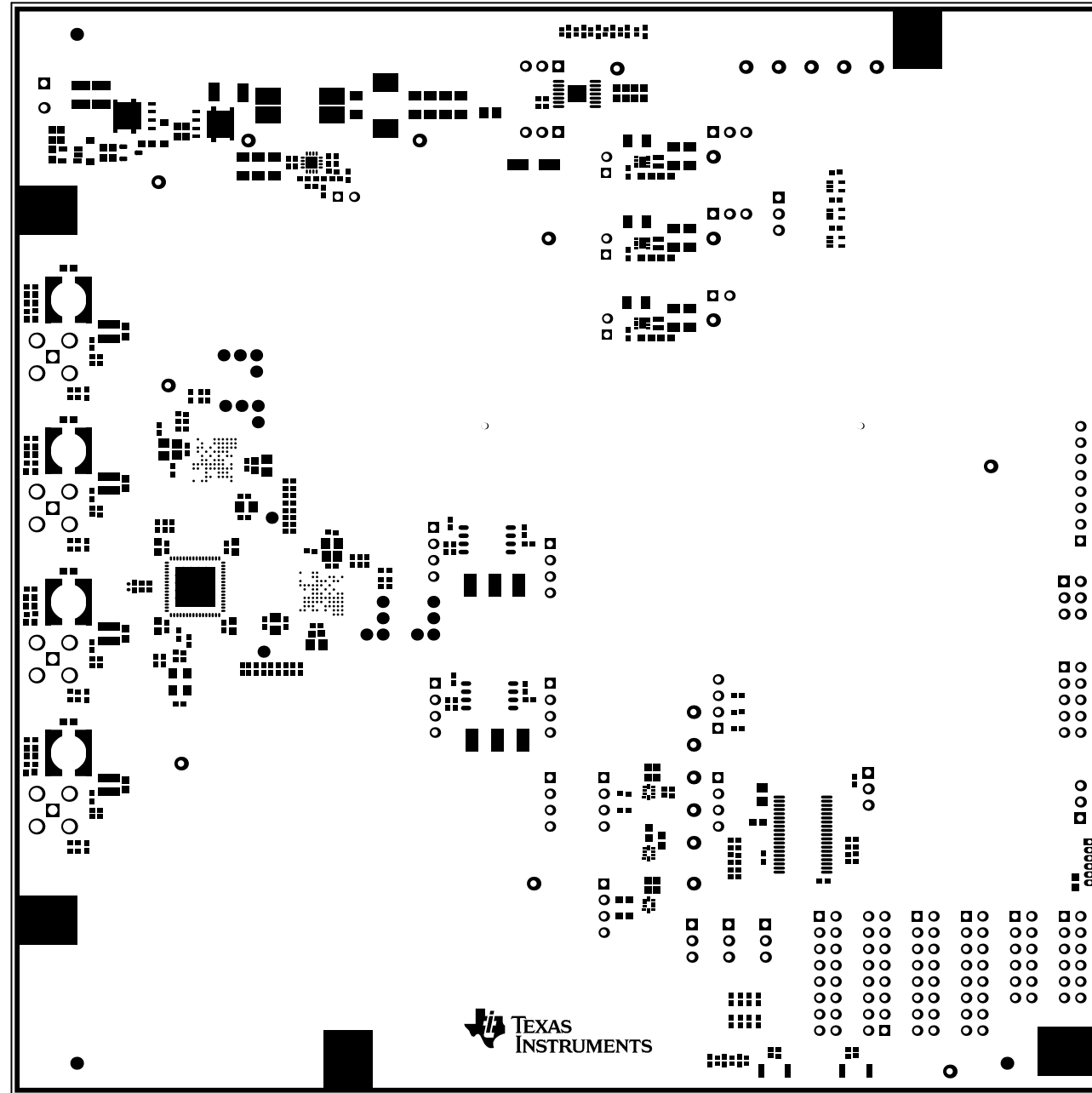
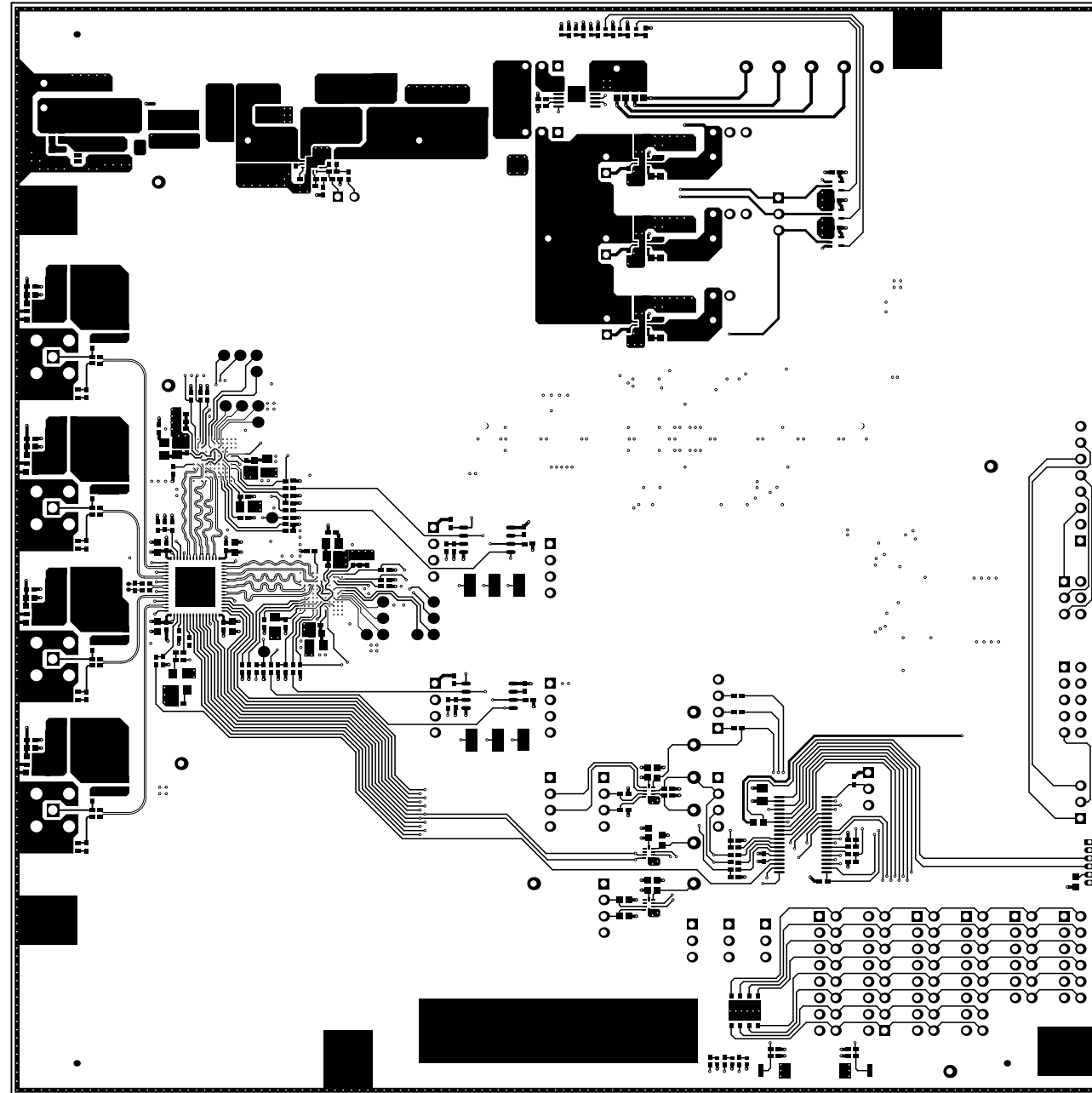


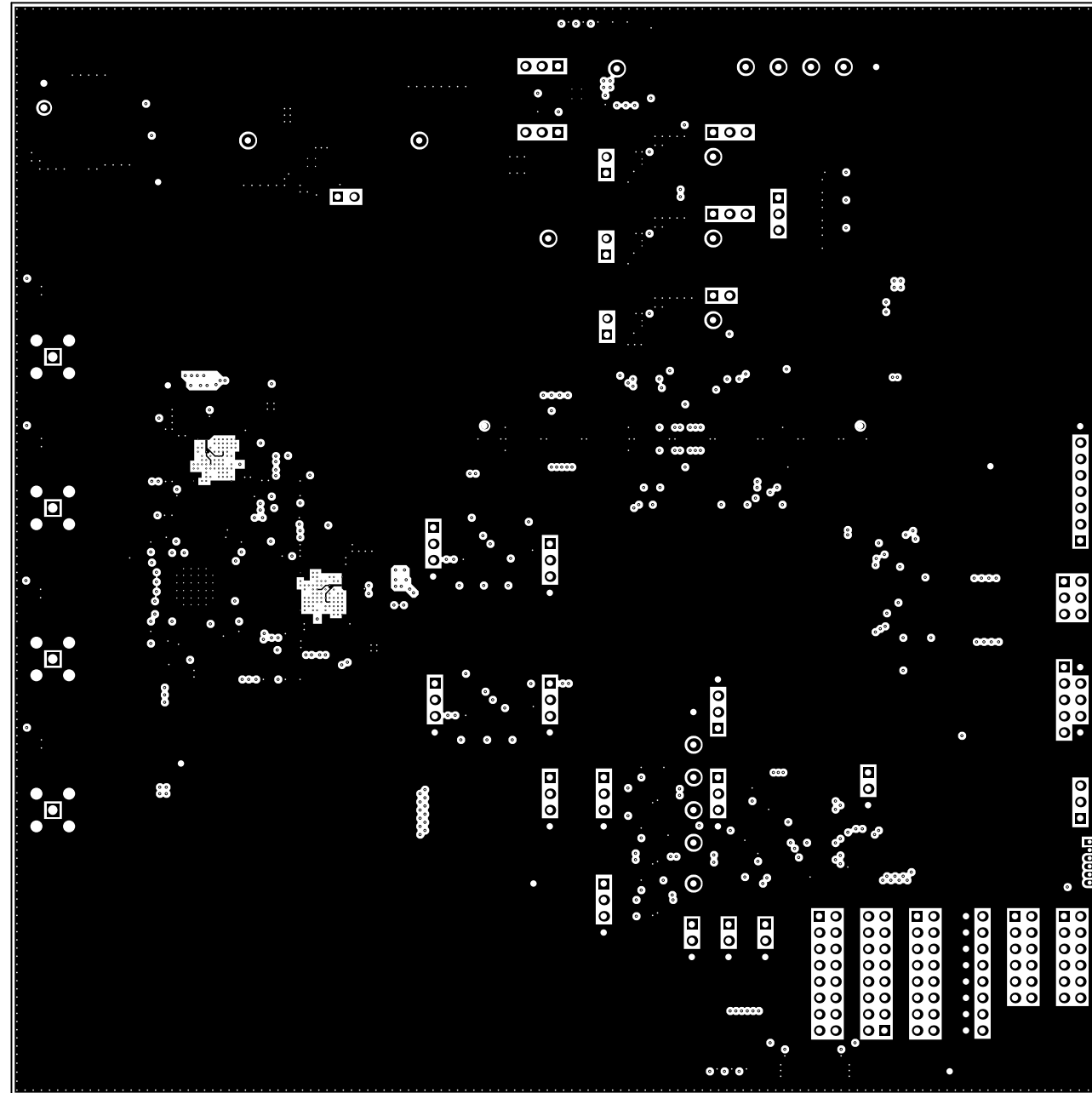
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00455	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 6/10/2015 2:54:55 PM	TEXAS INSTRUMENTS	



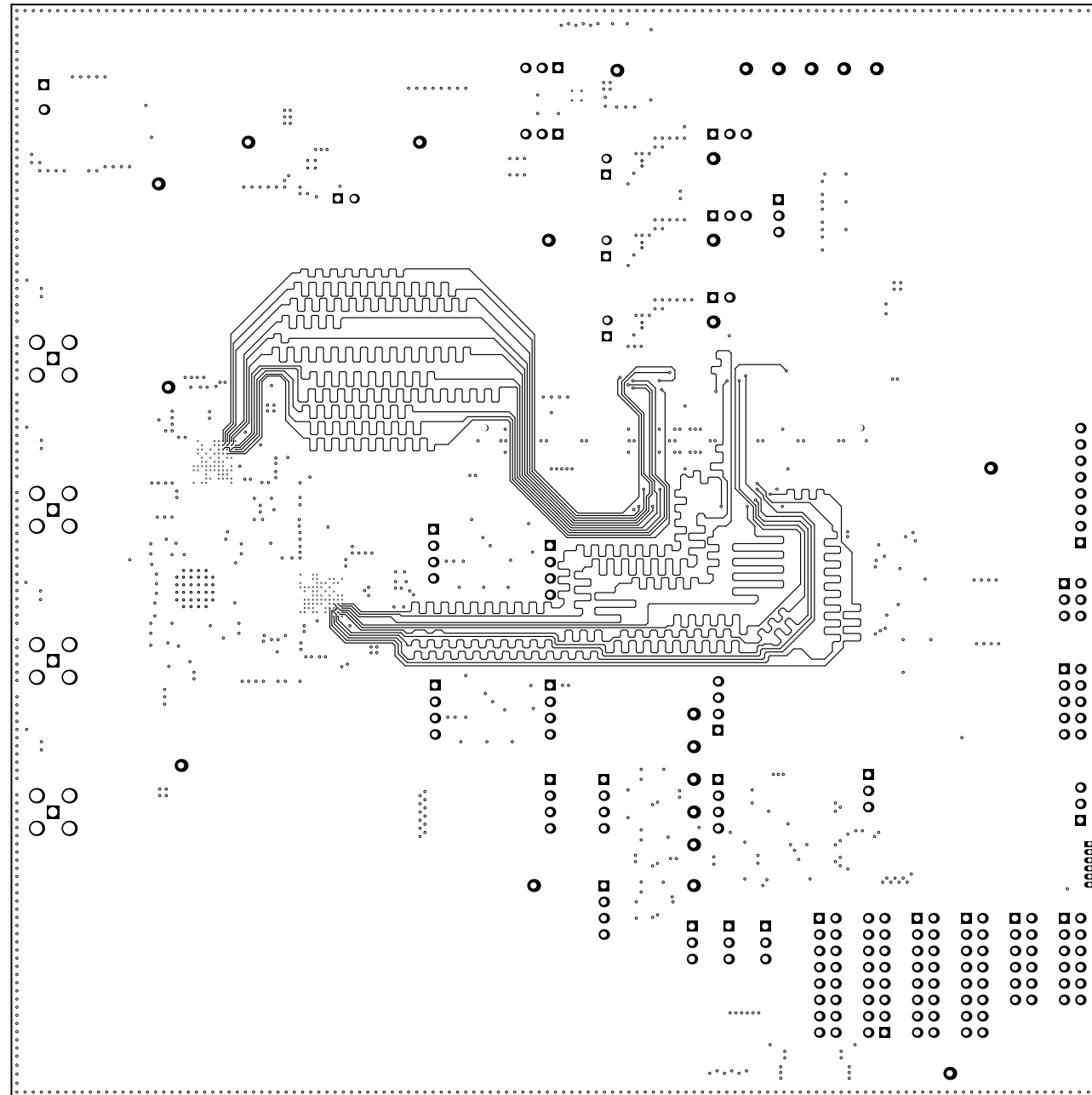
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00455	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 6/10/2015 2:55:01 PM	TEXAS INSTRUMENTS	



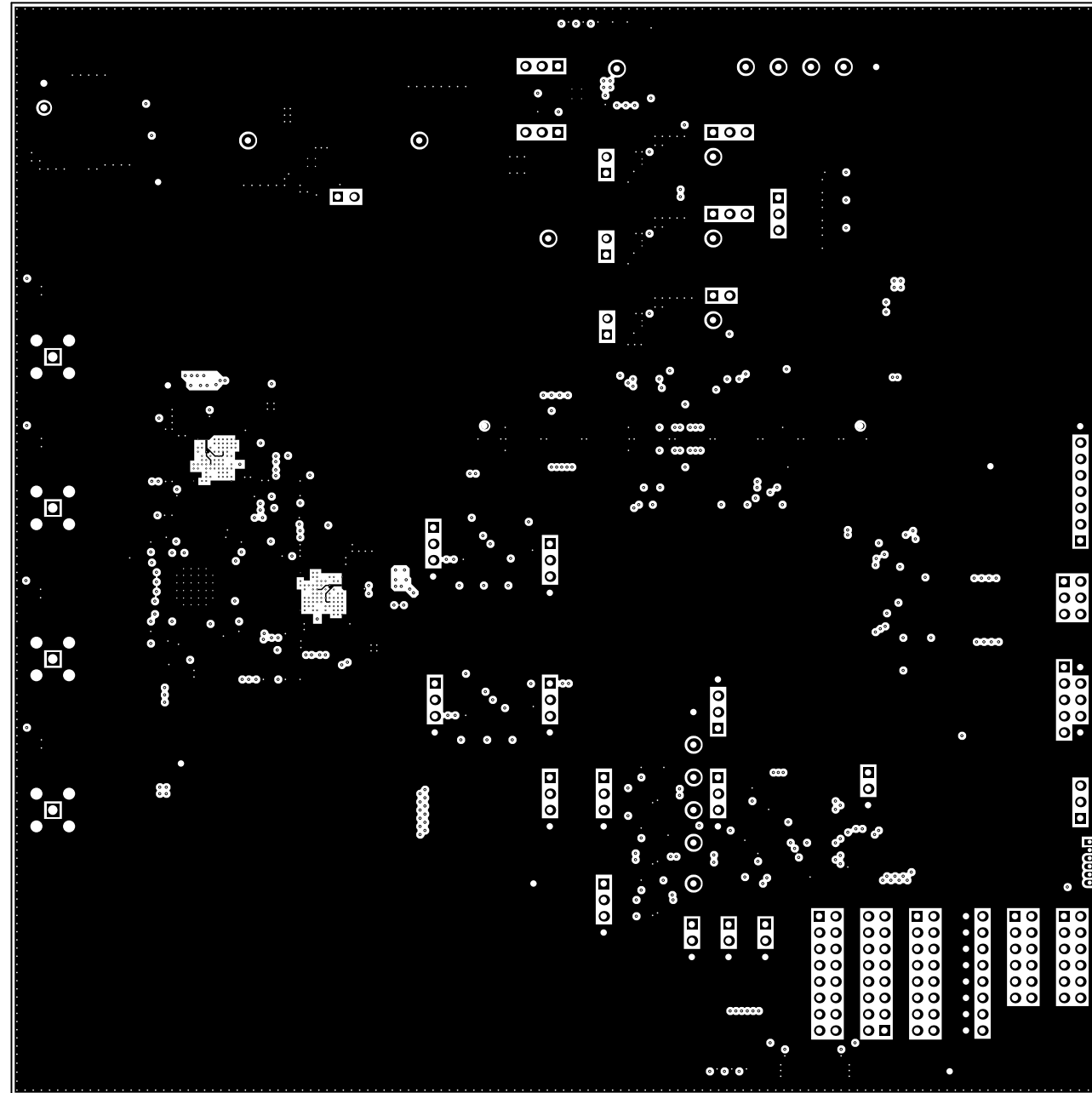
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00455	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Layer 1 - Top Layer			
PLOT NAME = Top Layer	GENERATED : 6/10/2015 2:55:08 PM	TEXAS INSTRUMENTS	



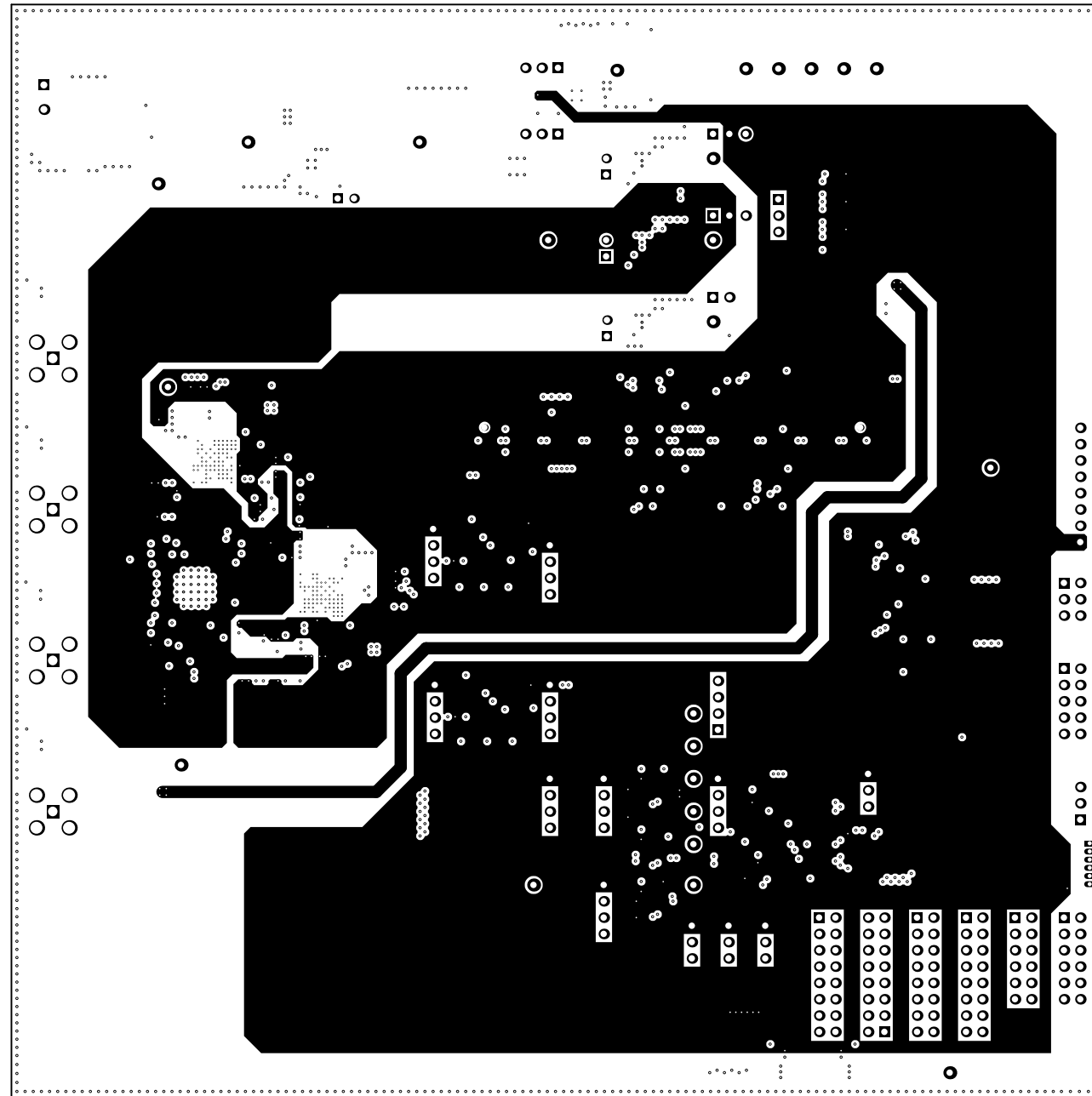
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00455	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Layer 2 - GND			
PLOT NAME = MidLayer1	GENERATED : 6/10/2015 2:55:16 PM	TEXAS INSTRUMENTS	



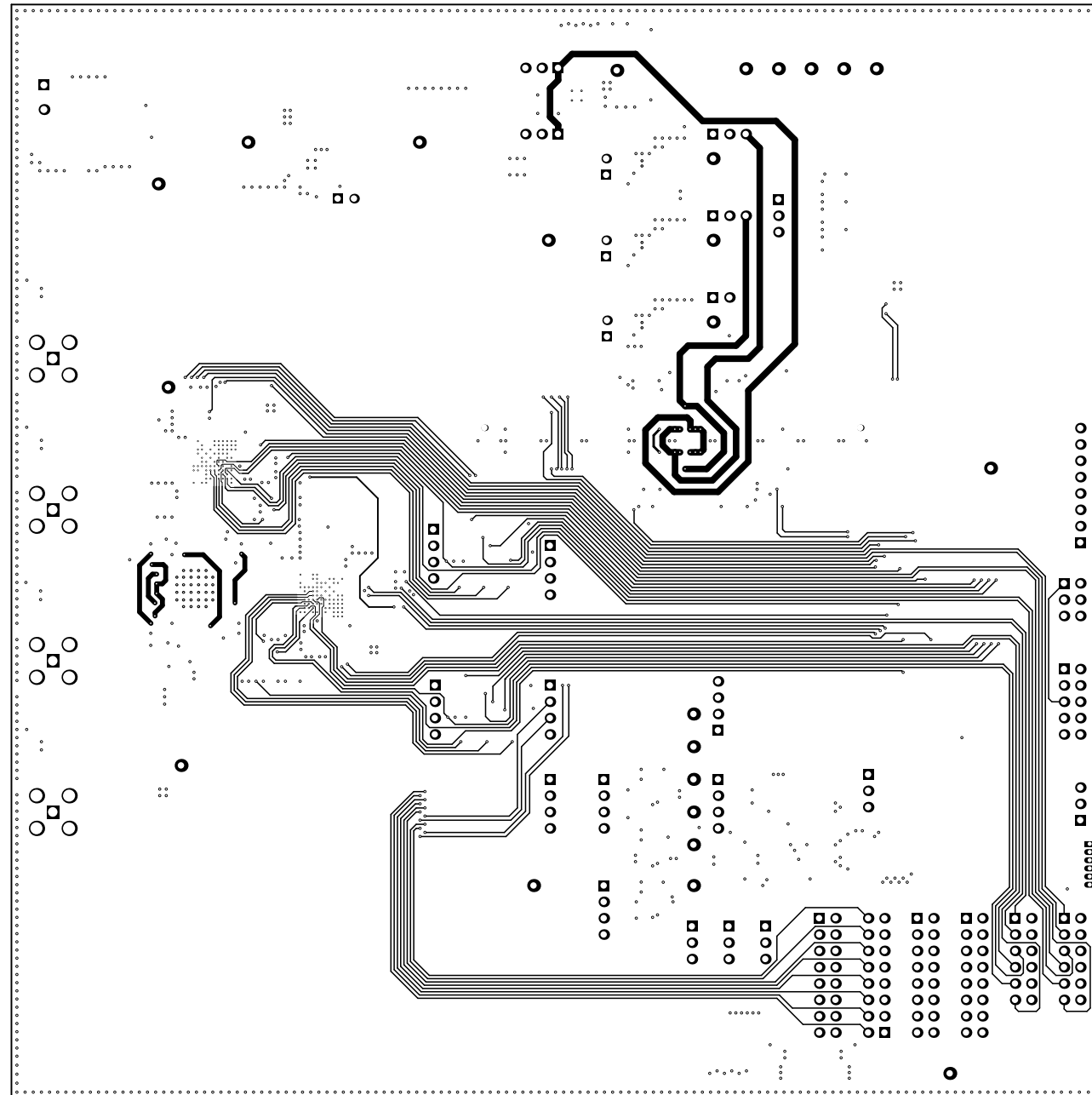
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00455	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Layer 3 - Sensitive			
PLOT NAME = MidLayer5	GENERATED : 6/10/2015 2:55:25 PM	TEXAS INSTRUMENTS	



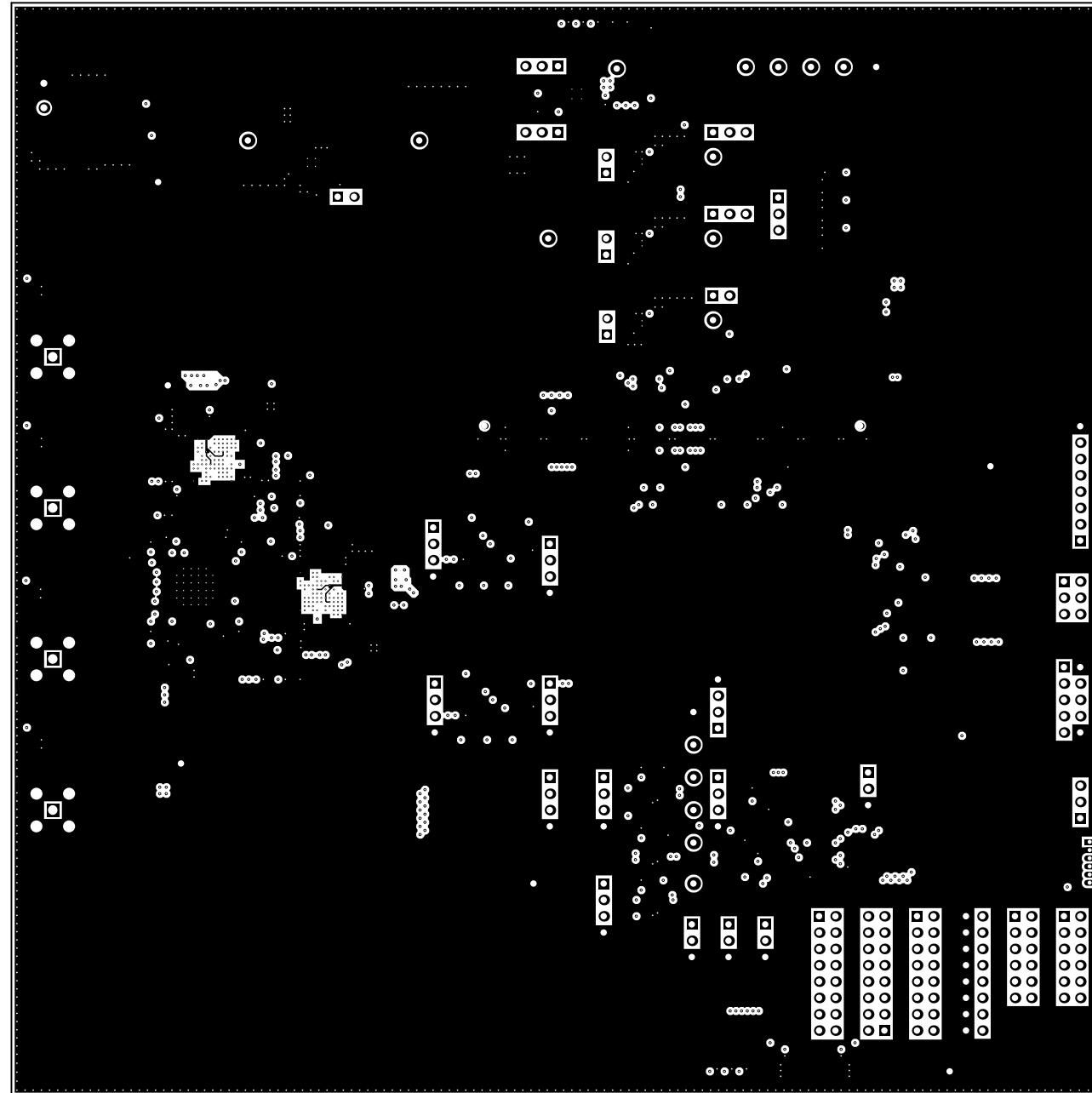
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00455	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Layer 4 - GND			
PLOT NAME = MidLayer6	GENERATED : 6/10/2015 2:55:34 PM	TEXAS INSTRUMENTS	



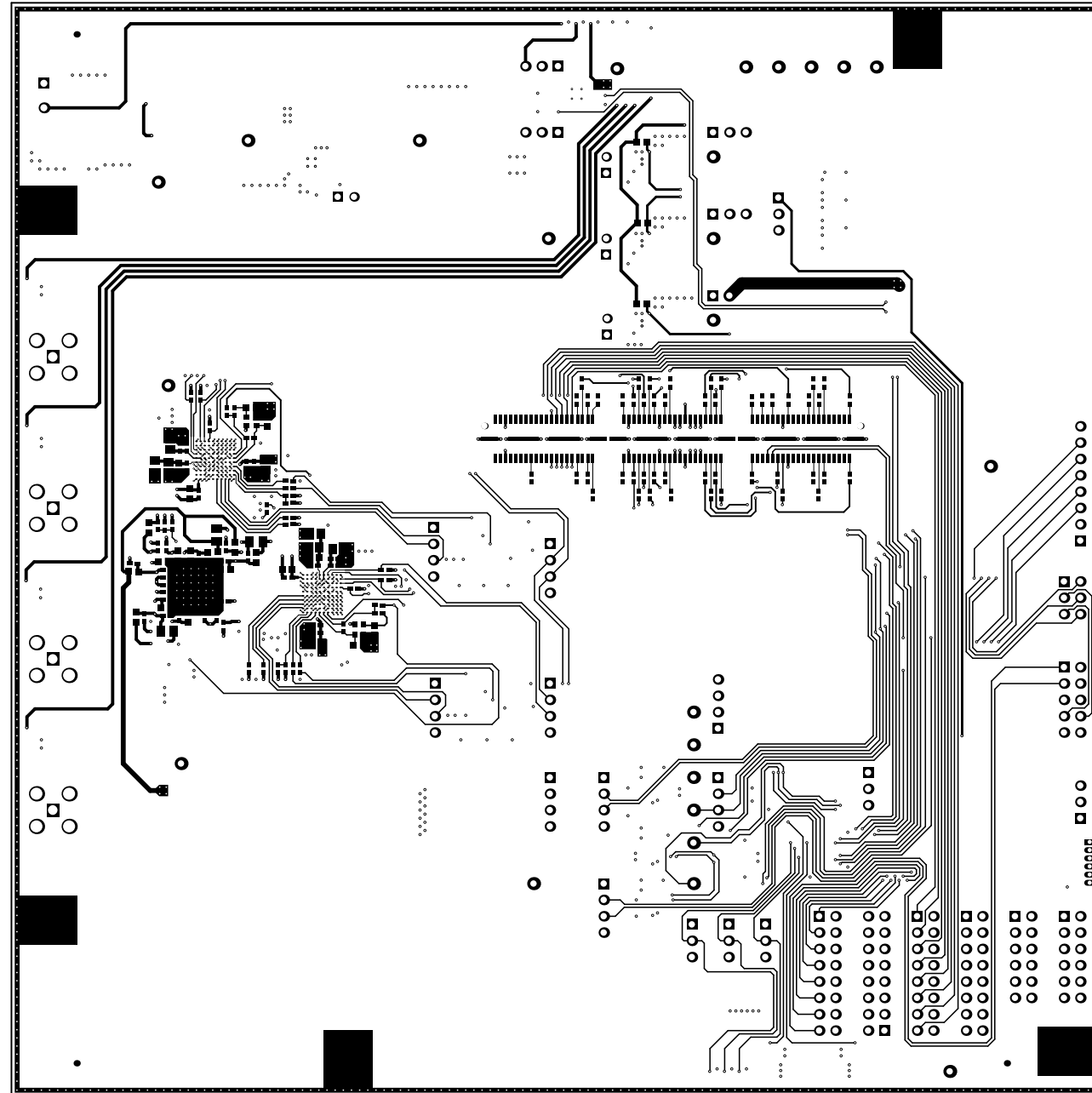
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00455	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Layer 5 - PWR			
PLOT NAME = MidLayer2	GENERATED : 6/10/2015 2:55:45 PM	TEXAS INSTRUMENTS	



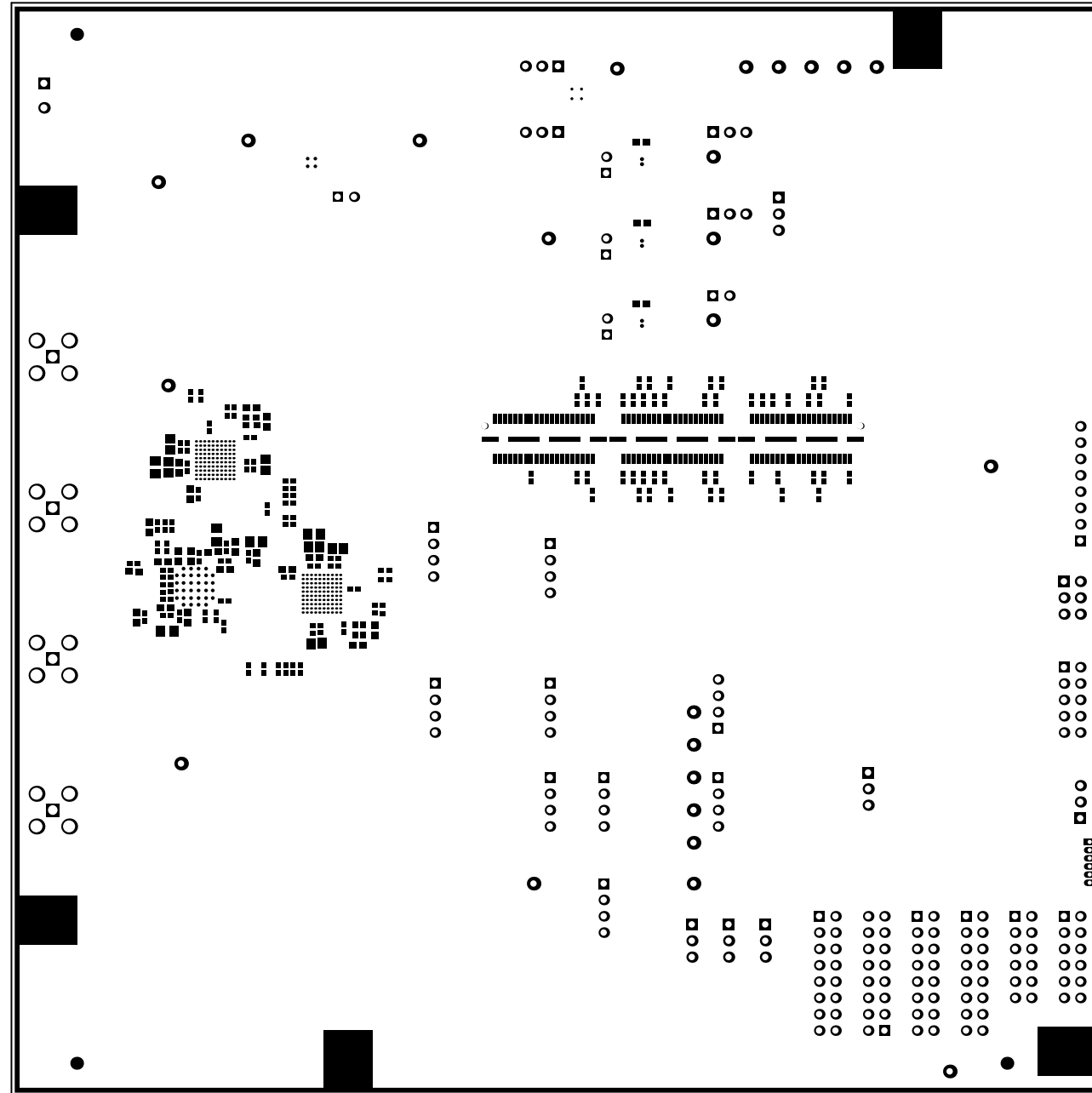
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00455	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Layer 6 - Signal			
PLOT NAME = MidLayer3	GENERATED : 6/10/2015 2:55:56 PM	TEXAS INSTRUMENTS	



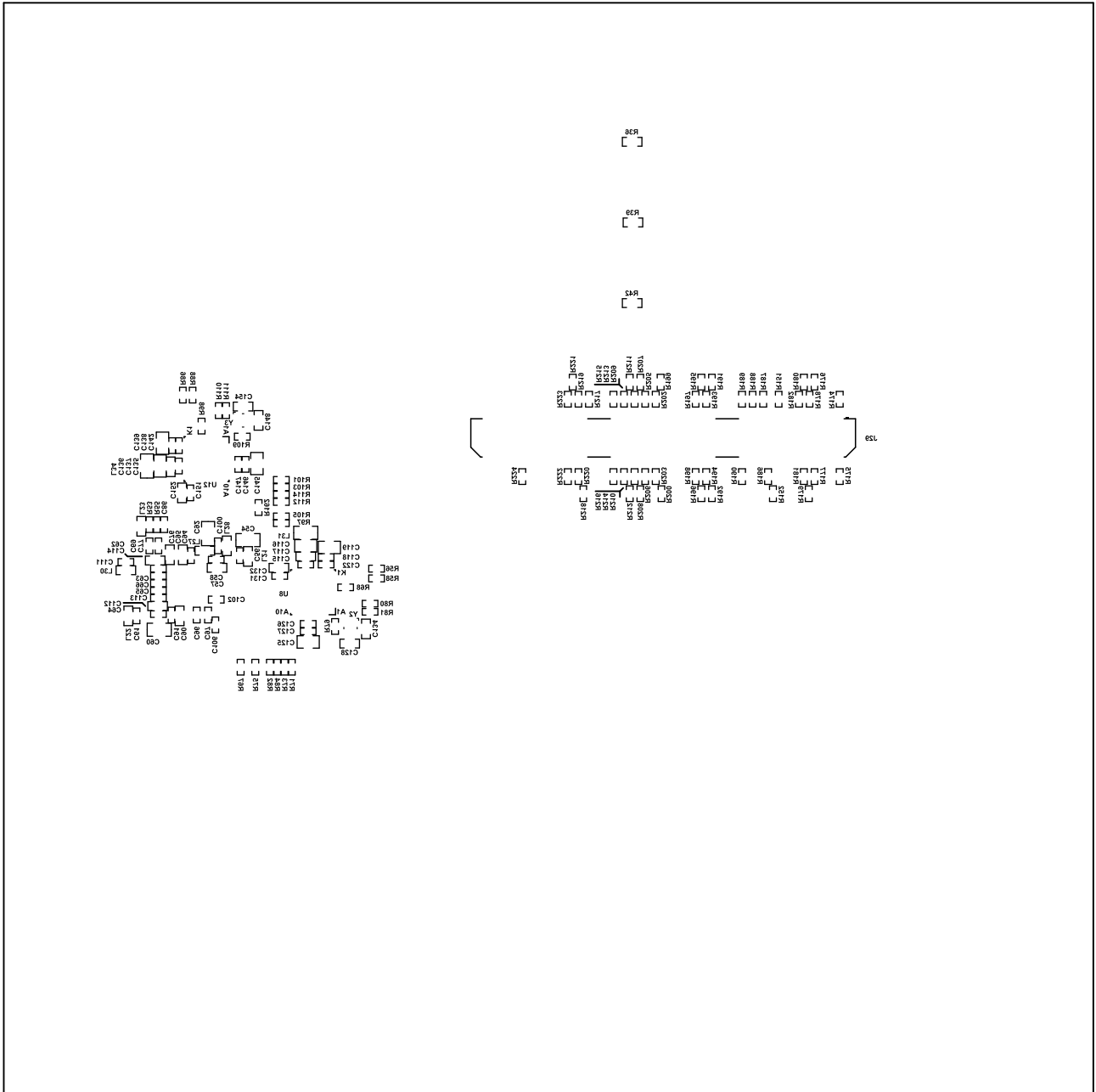
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00455	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Layer 7 - GND			
PLOT NAME = MidLayer4	GENERATED : 6/10/2015 2:56:08 PM	TEXAS INSTRUMENTS	



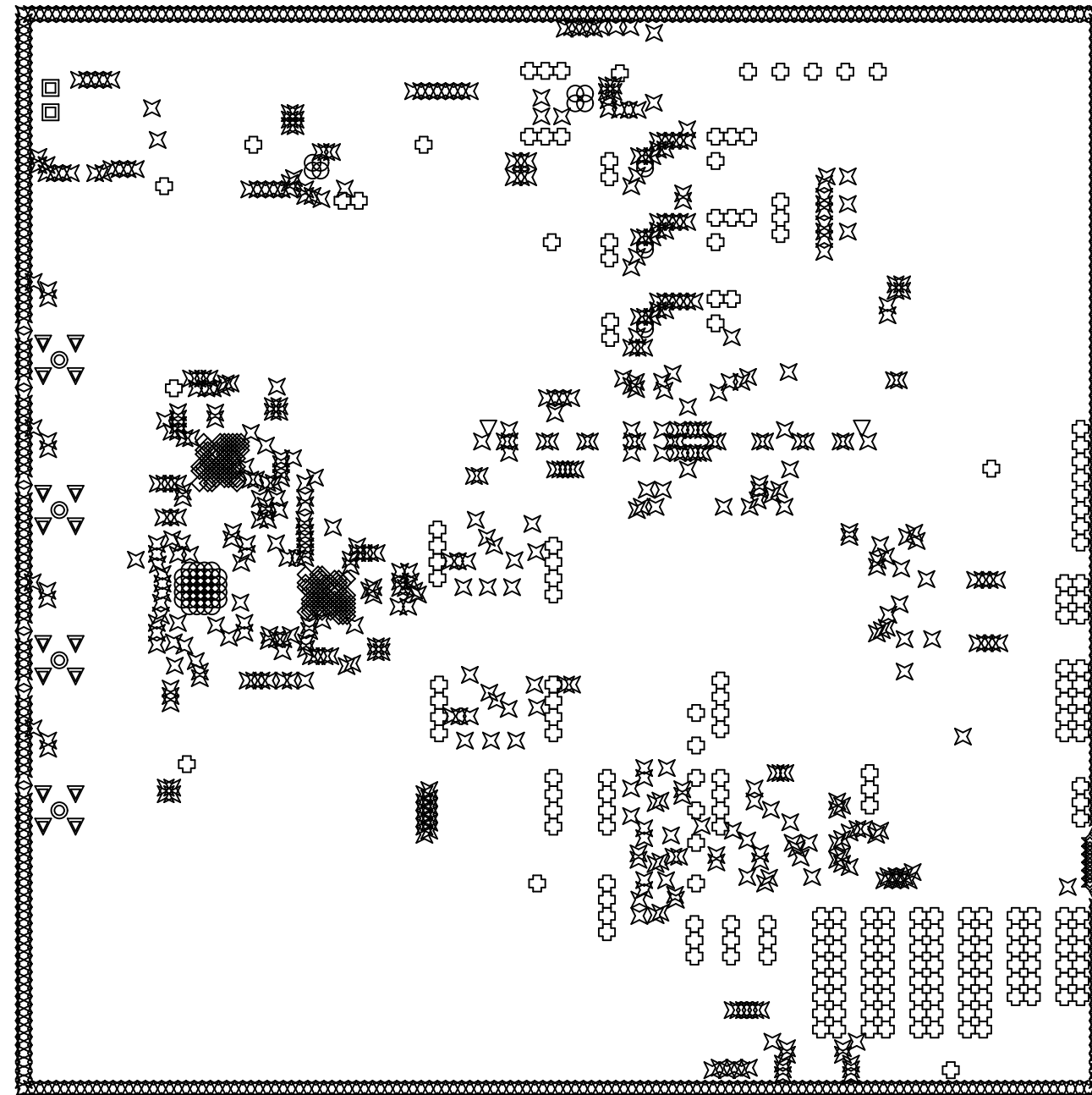
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00455	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Layer 8 - Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 6/10/2015 2:56:20 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00455	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 6/10/2015 2:56:34 PM	TEXAS INSTRUMENTS	

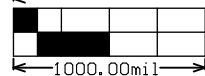
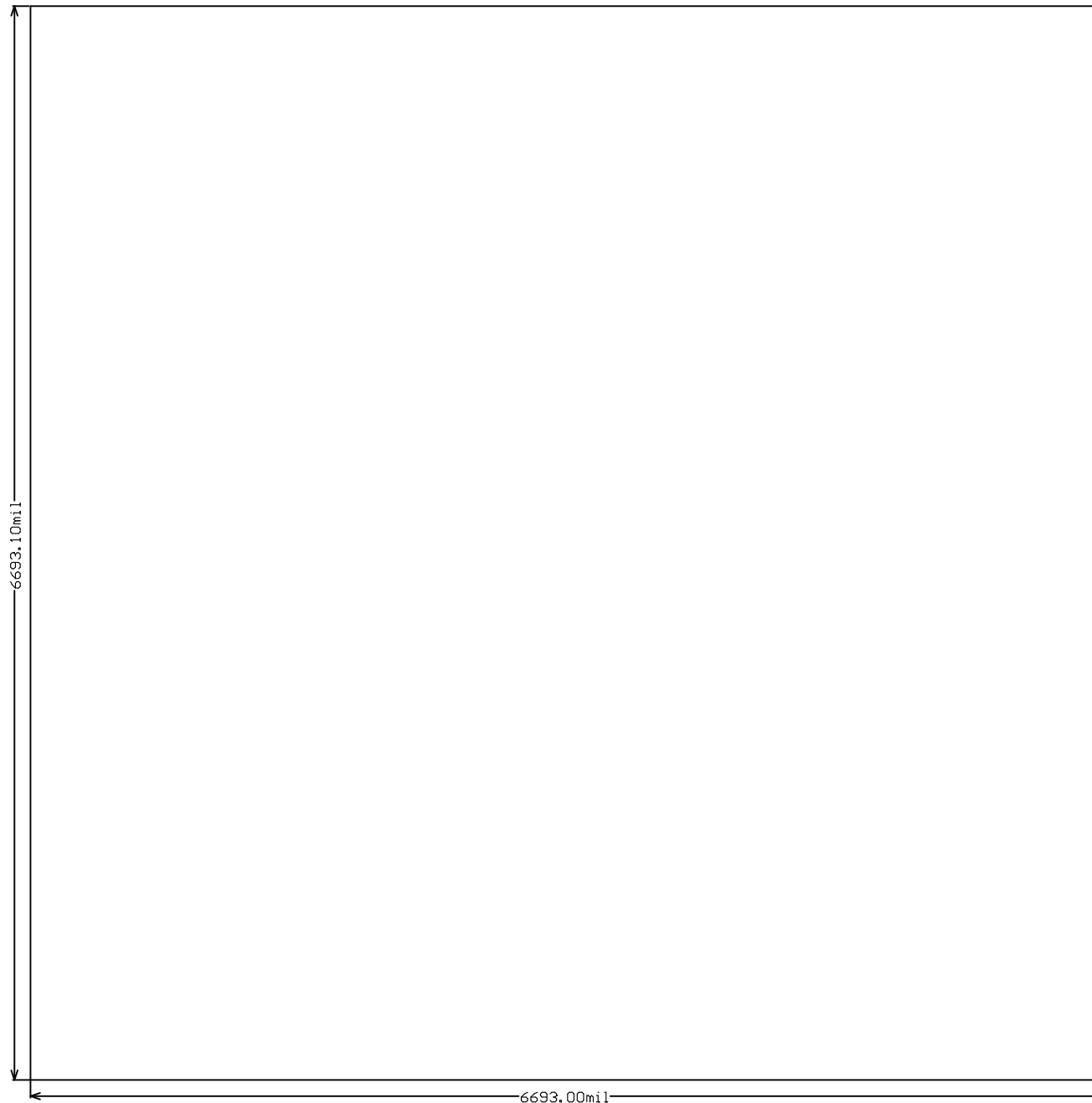


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00455	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 6/10/2015 2:56:48 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
▽	2	40.16mil (1.020mm)	NPTH	Round
◇	140	6.00mil (0.152mm)	PTH	Round
○	46	7.87mil (0.200mm)	PTH	Round
✕	1063	10.00mil (0.254mm)	PTH	Round
★	6	26.00mil (0.660mm)	PTH	Round
⊕	212	40.00mil (1.016mm)	PTH	Round
■	2	43.31mil (1.100mm)	PTH	Round
●	4	59.06mil (1.500mm)	PTH	Round
▽	16	74.80mil (1.900mm)	PTH	Round
1491 Total				

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00455	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 6/10/2015 2:57:04 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00455	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 6/10/2015 2:57:20 PM	TEXAS INSTRUMENTS	

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